

## technical datasheet

## **General description**

TECBOND 263 is a very high performance hotmelt specifically designed to bond polypropylene. This unique hotmelt provides excellent heat resistance and good low temperature performance.

To maximise bond strength on Polypropylene it is important that sufficient adhesive is applied between 375-400 °F and the surfaces brought together as quickly as possible. It is strongly recommended that a good quality high output glue gun is used to ensure consistent strong bonds.

Please note TECBOND 263 is specifically designed for bonding polypropylene and is not suitable for bonding other plastics

## **Technical characteristics**

Adhesive type: Synthetic polymer based hotmelt

Colour: Clear Molten tack: High

	1/2"	5/8"	13/4"
Form	½" x 12"		
Sticks per lb. (approx)	16		
Carton quantity	11lb ctn		
Pallet weight:	1100lb		
Suggested application temperature	375-400 °F		
Brookfield viscosity (POW-12-VISC) spindle 27	10,000cps @ 350°F		
Ring & ball softening point (ASTM E28)	302°F		
Heat resistance (BS5350 Part H3)	221°F		
Open time	Medium		
Low temperature flexibility (tg)	-4°F		
Applicators or hotmelt system	☐ Tec 150-12 ☐ Tec 150-12LM ☐ Tec 175-12 ☐ Tec 175-12LM ☐ Tec 250-12 ☐ Tec 250-12LM ☐ Gastec 100 ☐ Gastec 300 ☐ Gastec 500 ☑ Tec 810-12 ☐ Tec 810-12LM	☐ Tec 810-15 ☐ Tec 810-15LM	Tec 3150-43 Tec Tec 3200-43 Tec 6100-43 Tec 6300-43 Tec 7100-43 Tec 7300-43

F.D.A. approved. All the constituent parts of this adhesive have been approved by the American F.D.A. under C.F.R. 21.175.105 (adhesives) (subject to limitations).

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Tecbond Reference	Description	1/2"	5/8"	1¾"	СТ	Bulk
5	High delivery, low viscosity, long open time.Product assembly adhesive.	•		•	•	•
14	High delivery, very fast setting packaging adhesive.	•	•	•		
1942	Product assembly adhesive for wood and many plastics.	•	•	•		
1X	Low viscosity, wood working & packaging adhesive. Medium open time.	•		•		
213	Economical, general purpose adhesive.	•	•	•		
214	Economical, fast setting, packaging adhesive.	•	•	•		
23	Medium viscosity multipurpose adhesive.	•	•	•		
232	Economical, clear, general purpose adhesive.	•	•	•		
232 Coloured	Coloured, medium open time, general purpose adhesive. Brown, Green, White, Black, Blue, Gold, Silver, Red, Yellow.	•				
232 Glitter	Multicolour, Red, Green, Silver, Gold.	•				
240	High delivery, long open time, multipurpose, clear adhesive.	•	•	•		
246	Clear and black versions, high performance, gap filling, difficult surfaces, dent pulling.	•				
260	High performance, long open time, tough, flexible adhesive.	•	•	•		
265	Long open time product assembly adhesive for smooth and shiny surfaces.			•		
267	High heat resistant, medium open time, product assembly adhesive.			•		
2169	Peelable adhesive, low tack, non-migrating, CD & credit card attachment, glue dots.				•	•
342	High viscosity, fast setting, white adhesive.	•		•		
410	Pallet stabilisation spray adhesive			•		
420	General purpose spray adhesive.			•		
425	High delivery, high performance, spray adhesive.			•		
430	High performance, long open time spray adhesive.			•		
4741	Full pressure sensitive, very aggressive, multipurpose, paper & plastic materials.				•	•
7718	Coloured, low viscosity, potting, encapsulation & knot filling / wood repair polyamide adhesive.	•	•			
7784	High temperature resistant multipurpose polyamide adhesive.	•	•	•		
7785	High temperature & chemical resistant multipurpose polyamide adhesive.	•	•	•		
9010	Reactive hotmelt. Heat & chemical resistant bonds, rigid bond, once set does not reactivate with heat.				•	
9030	Reactive hotmelt. Heat & chemical resistant bonds, flexible bond, once set does not reactivate with heat.				•	
LM44	Lowmelt, fast setting, high performance, white adhesive.	•		•		

Storage Store in a clean dry place at temperatures between 41°F and 86°F with boxes closed. Do not expose to direct sunlight or localised heat

sources such as radiators or hot pipes.

Removal of glue Assembled components can be separated by heating assembly to a temperature slightly above the heat resistance figure.

EVA & Polypropylene: Residues of EVA and polypropylene based hotmelts can be removed from components with white spirit.

Polyamide: Residues of polyamide based hotmelt can be removed from components with acetone.

PUR: Prior to cross linking adhesive can be removed with white spirit or ketone. Once fully cross linked the adhesive cannot be easily

removed.

Please note The information contained on this data sheet is for guidance only. It is the result of careful laboratory evaluations by trained and

qualified staff using British Standard or similar test methods. However, no warranty is expressed or implied regarding the accuracy of the data or the suitability of the adhesive for any specific purpose. In every case, we strongly recommend that the user shall make their own test to determine to their own satisfaction the suitability of the adhesive for their particular purpose. Neither the seller nor manufacturer shall be liable for any injury, loss, damage, direct or consequential arising out of the use or inability to use the product. Further information is always available to help solve your adhesive problems. Should you require any further information on our

adhesives please contact your nearest distributor.



